

NOTES : 1. Thermal Resistance (Junction to Ambient), .24in₂ (6.0mm₂) copper pads to each terminal.

2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.

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Cu

TJ, TSTG

200

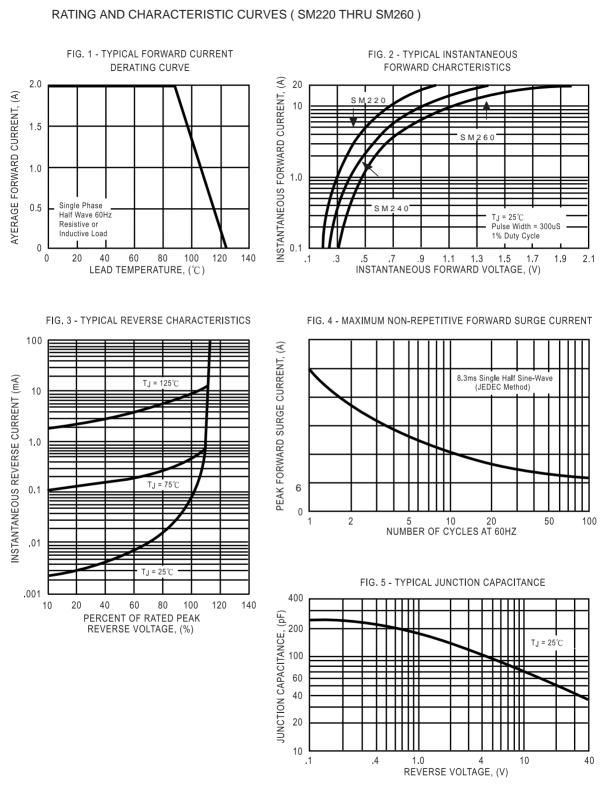
-65 to + 125

рF

٥C

Typical Junction Capacitance (Note 2)

Storage Operating Temperature Range



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